

In the Claims(Clean version)

*also added*  
4. The semiconductor cassette reducer of claim 1, wherein a base to tip distance of the first substantially U-shaped plate is less than an interior depth of a front opening unified pod.

*also added*  
18. The semiconductor cassette reducer of claim 14, wherein a base to tip distance of the first substantially U-shaped plate is less than a diameter of wafer designed for a front opening unified pod.